

Notice of References CitedApplication/Control No.
09/985,904Applicant(s)/Patent Under
Reexamination
IWASAKI ET AL.Examiner
Stephen W. SmootArt Unit
2813

Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-			
	B	US-			
	C	US-			
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FOREIGN PATENT DOCUMENTS

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NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	"Diffusion Barrier Between Copper and Silicon," IBM Technical Disclosure Bulletin Vol. 35, No. 1B, pp. 214-215, June 1992.
	V	
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
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